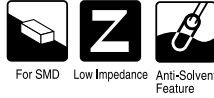


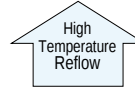
WD

Chip Type, Low Impedance
High Temperature (260°C) Reflow
series



- Corresponding with 260°C peak reflow soldering
Recommended reflow condition : 260°C peak 5 sec. 230°C over 60 sec.
2 times ($\phi 10 \times 10$, : 1 time)
- Chip type, low impedance temperature range up to +105°C.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine using carrier tape.
- Adapted to the RoHS directive (2002/95/EC).

WD



UD

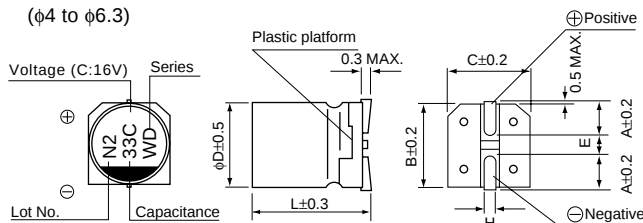


Specifications

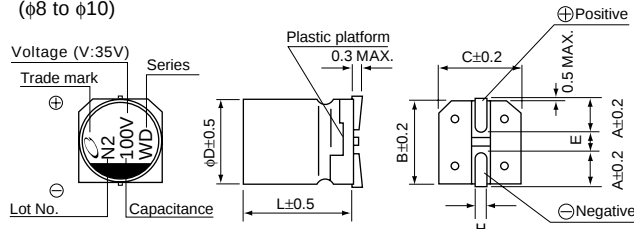
Item	Performance Characteristics							
Category Temperature Range	-55 to +105°C							
Rated Voltage Range	6.3 to 50V							
Rated Capacitance Range	1 to 1500μF							
Capacitance Tolerance	±20% at 120Hz, 20°C							
Leakage Current	After 2 minutes' application of rated voltage, leakage current is not more than 0.01 CV or 3 (μA), whichever is greater.							
tan δ	Measurement frequency : 120Hz, Temperature : 20°C							
	Rated voltage (V)	6.3	10	16	25	35	50	
	tan δ (MAX.)	0.26 (0.28)	0.20 (0.24)	0.16 (0.20)	0.14 (0.16)	0.12 (0.14)	0.12 (0.14)	
() is φ8 over								
Stability at Low Temperature	Measurement frequency : 120Hz							
	Rated voltage (V)		6.3	10	16	25	35	50
	Impedance ratio	Z-25°C / Z+20°C	3	2	2	2	2	2
	ZT / Z20 (MAX.)	Z-55°C / Z+20°C	5	4	4	3	3	3
Endurance	After 5000 hours' (2000 hours for φD ≤ 6.3) application of rated voltage at 105°C , capacitors meet the characteristic requirements listed at right.				Capacitance change		Within ±30% of initial value	
					tan δ		200% or less of initial specified value	
					Leakage current		Initial specified value or less	
Shelf Life	After storing the capacitors under no load at 105°C for 1000 hours, and after performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they will meet the specified value for endurance characteristics listed above.							
Resistance to soldering heat	The capacitors shall be kept on the hot plate maintained at 250°C for 30 seconds. After removing from the hot plate and restored at room temperature, they meet the characteristic requirements listed at right.				Capacitance change		Within ±10% of initial value	
					tan δ		Initial specified value or less	
					Leakage current		Initial specified value or less	
Marking	Black print on the case top.							

Chip Type

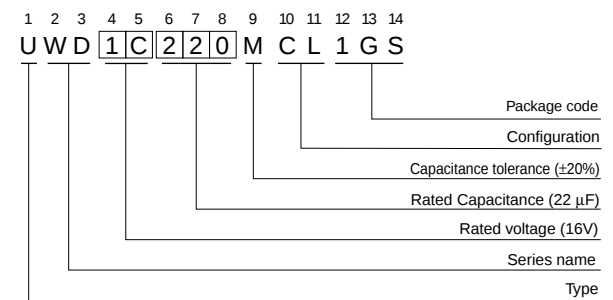
(φ4 to φ6.3)



(φ8 to φ10)



Type numbering system (Example : 16V 22μF)



φD × L	4 × 5.8	5 × 5.8	6.3 × 5.8	6.3 × 7.7	8 × 10	10 × 10
A	1.8	2.1	2.4	2.4	2.9	3.2
B	4.3	5.3	6.6	6.6	8.3	10.3
C	4.3	5.3	6.6	6.6	8.3	10.3
E	1.0	1.3	2.2	2.2	3.1	4.5
L	5.8	5.8	5.8	7.7	10	10
H	0.5 to 0.8	0.5 to 0.8	0.5 to 0.8	0.5 to 0.8	0.8 to 1.1	0.8 to 1.1

Voltage

V	6.3	10	16	25	35	50
Code	j	A	C	E	V	H

● Dimension table in next page.

CAT.8100W

■ Dimensions

Cap. (μ F)	V Code	6.3			10			16			25			35			50		
		0J			1A			1C			1E			1V			1H		
1	010																4×5.8	5.00	30
2.2	2R2																4×5.8	5.00	30
3.3	3R3																4×5.8	5.00	30
4.7	4R7													4×5.8	1.80	80	5×5.8	1.52	85
10	100										4×5.8	1.80	80	5×5.8	0.76	150	6.3×5.8	0.88	165
15	150							4×5.8	1.80	80	5×5.8	0.76	150	5×5.8	0.76	150	6.3×5.8	0.88	165
22	220				4×5.8	1.80	80	5×5.8	0.76	150	5×5.8	0.76	150	5×5.8	0.76	150	6.3×5.8	0.88	165
27	270	4×5.8	1.80	80	5×5.8	0.76	150	5×5.8	0.76	150	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.68	185
33	330	5×5.8	0.76	150	5×5.8	0.76	150	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.68	185
47	470	5×5.8	0.76	150	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.68	185
56	560	5×5.8	0.76	150	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.34	280	8×10	0.34	300
68	680	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.34	280	8×10	0.34	300
100	101	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.34	280	8×10	0.17	450	8×10	0.34	300
150	151	6.3×5.8	0.44	230	6.3×5.8	0.44	230	6.3×7.7	0.34	280	8×10	0.17	450	8×10	0.17	450	10×10	0.18	670
220	221	6.3×5.8	0.44	230	6.3×7.7	0.34	280	6.3×7.7	0.34	280	8×10	0.17	450	10×10	0.09	670	10×10	0.18	670
330	331	6.3×7.7	0.34	280	8×10	0.17	450	8×10	0.17	450	10×10	0.09	670	10×10	0.09	670			
470	471	8×10	0.17	450	8×10	0.17	450	8×10	0.17	450	10×10	0.09	670						
680	681	8×10	0.17	450	10×10	0.09	670	10×10	0.09	670									
1000	102	10×10	0.09	670	10×10	0.09	670												
1500	152	10×10	0.09	670													Case size ϕ D × L (mm)	Impedance	Rated ripple

Max. Impedance (Ω) at 20°C 100kHz,
Rated Ripple (mA_{rms}) at 105°C 100kHz

● Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Coefficient	0.35	0.50	0.64	0.83	1.00

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please refer to page 3 for the minimum order quantity.